Integrated Load Switch

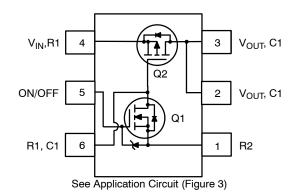
FDC6326L

Description

This device is particularly suited for compact power management in portable electronic equipment where 3 V to 20 V input and 1.8 A output current capability are needed. This load switch integrates a small N–Channel power MOSFET (Q1) which drives a large P–Channel power MOSFET (Q2) in one tiny SUPERSOTTM–6 package.

Features

- $V_{DROP} = 0.20 \text{ V}$ @ $V_{IN} = 12 \text{ V}$, $I_L = 1.5 \text{ A}$, $R_{DS(on)} = 0.125 \Omega$
- $V_{DROP} = 0.20 \text{ V} @ V_{IN} = 5 \text{ V}, I_L = 1 \text{ A}, R_{DS(on)} = 0.20 \Omega$
- SUPERSOT-6 Package Design Using Copper Lead Frame for Superior Thermal and Electrical Capabilities
- This is a Pb–Free and Halide Free Device





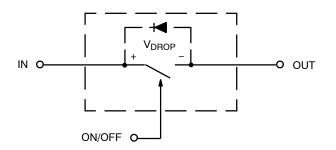


Figure 2. Equivalent Circuit



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TSOT-23-6 CASE 419BL

MARKING DIAGRAM



= Designates Space

= Binary Calendar Year Coding Scheme

= Pin One Dot

326 = Specific Device Code

&G = Date Code

&Ε

&Y

&.

ORDERING INFORMATION

Device	Package	Shipping [†]
FDC6326L	TSOT-23-6 (Pb-Free)	3000 / Tape & Reel

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

FDC6326L

ABSOLUTE MAXIMUM RATINGS $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Unit
V _{IN}	Input Voltage Range	3–20	V
V _{ON/OFF}	On/Off Voltage Range	2.5–8	V
١L	Load Current – Continuous (Note 1)	1.8	А
	Load Current – Pulsed (Note 1, Note 3)	5	
PD	Maximum Power Dissipation (Note 2)	0.7	W
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to 150	°C
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100 pF/1500 Ω)	6	kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS T_{A} = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 2)	180	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 2)	60	°C/W

ELECTRICAL CHARACTERISTICS $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARAC	TERISTICS	•				
I _{FL}	Forward Leakage Current	$V_{IN} = 20 \text{ V}, V_{ON/OFF} = 0 \text{ V}$	-	-	1	μA
ON CHARAC	TERISTICS (Note 3)					
V _{DROP}	Conduction Voltage Drop	V_{IN} = 12 V, $V_{ON/OFF}$ = 3.3 V, I_L = 1.5 A	-	0.15	0.2	V
		$V_{IN} = 5 \text{ V}, \text{ V}_{ON/OFF} = 3.3 \text{ V}, \text{ I}_{L} = 1 \text{ A}$	-	0.14	0.2	
R _{DS(on)}	Q ₂ – Static On–Resistance	$V_{GS} = -12 \text{ V}, \text{ I}_{D} = -1.9 \text{ A}$	-	0.095	0.125	Ω
		$V_{GS} = -5 \text{ V}, \text{ I}_{D} = -1.5 \text{ A}$	-	0.14	0.2	
١ _L	Load Current	$V_{DROP} = 0.125 \text{ V}, V_{IN} = 12 \text{ V}, V_{ON/OFF} = 3.3 \text{ V}$	1	-	-	Α
		V _{DROP} = 0.20 V, V _{IN} = 5 V, V _{ON/OFF} = 3.3 V	1	-	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NOTES:

1. $V_{IN} = 20 \text{ V}, V_{ON/OFF} = 8 \text{ V}, T_A = 25^{\circ}\text{C}$ 2. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta,JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design. 3. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.

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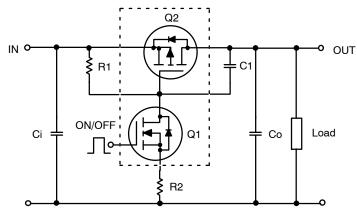


Figure 3. FDC6326L Load Switch Application

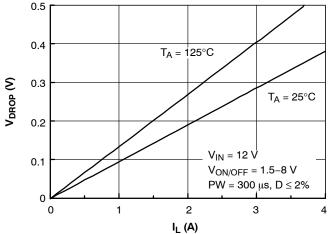
External Component Recommendation:

First select R2, 100-1 kΩ, for Slew Rate control.

 $C1 \le 1000 \text{ pF}$ can be added in addition to R2 for further In-rush current control.

Then select R1 such that R1/R2 ratio maintains between 10–100. R1 is required to turn Q2 off.

For SPICE simulation, users can download a "FDC6326L.MOD" Spice model from ON Semiconductor Web Site at www.onsemi.com





TYPICAL CHARACTERISTICS

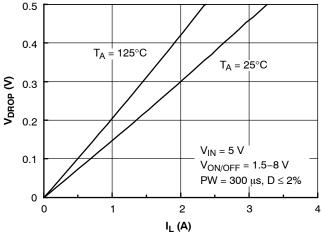


Figure 5. Conduction Voltage Drop Variation with Load Current

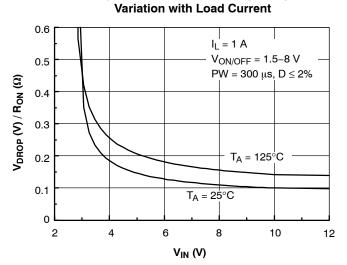


Figure 4. Conduction Voltage Drop

Figure 6. On-Resistance Variation with Input Voltage

FDC6326L

TYPICAL CHARACTERISTICS (continued)

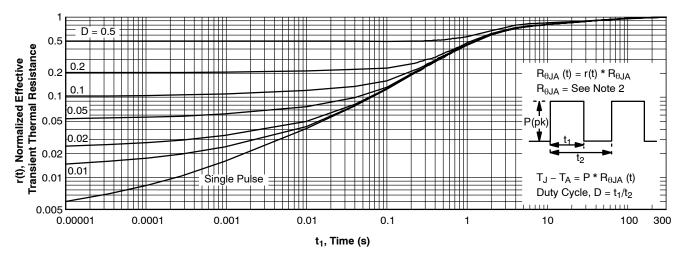
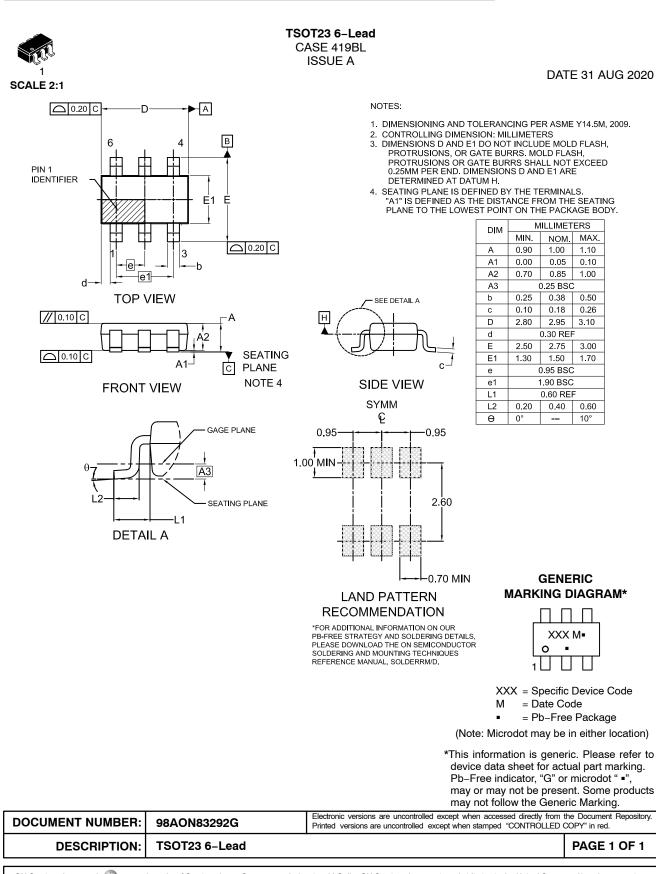


Figure 7. Transient Thermal Response Curve

NOTE: Thermal characterization performed on the conditions described in Note 2.

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